Taiwan Semiconductor

1A, 50V - 1000V High Efficient Bridge Rectifier

FEATURES

- Glass passivated chip junction
- Ideal for printed circuit board
- Reliable low cost construction utilizing molded plastic technique
- High surge current capability
- UL Recognized File # E-326854
- AEC-Q101 qualified available
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- Lighting application

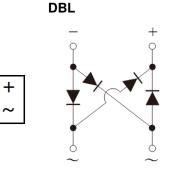
MECHANICAL DATA

- Case: DBL
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 0.360g (approximately)

KEY PARAMETERS					
PARAMETER	VALUE	UNIT			
I _F	1	А			
V _{RRM}	50 - 1000	V			
I _{FSM}	50	А			
T _{J MAX}	150 °C				
Package	DBL				
Configuration	Quad				







ABSOLUTE MAXIMUM RATINGS ($T_A = 25^{\circ}C$ unless otherwise noted)									
PARAMETER	SYMBOL	HDBL	HDBL	HDBL	HDBL	HDBL	HDBL	HDBL	UNIT
		101G	102G	103G	104G	105G	106G	107G	
Marking code on the device		HDBL 101G	HDBL 102G	HDBL 103G	HDBL 104G	HDBL 105G	HDBL 106G	HDBL 107G	
Repetitive peak reverse voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Reverse voltage, total rms value	V _{R(RMS)}	35	70	140	280	420	560	700	V
Forward current	I _F	1				Α			
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	I _{FSM}	_{FSM} 50					А		
Rating for fusing (t<8.3ms)	l ² t	l ² t 10.3					A ² s		
Junction temperature	TJ	T _J - 55 to +150				°C			
Storage temperature	T _{STG}	T _{STG} - 55 to +150				°C			



THERMAL PERFORMANCE						
PARAMETER	SYMBOL	ТҮР	UNIT			
Junction-to-lead thermal resistance	$R_{\Theta JL}$	15	°C/W			
Junction-to-ambient thermal resistance	R _{eJA}	40	°C/W			

ELECTRICAL SPECIFICATIONS ($T_A = 25^{\circ}C$ unless otherwise noted)						
PARAMETER		CONDITIONS	SYMBOL	ТҮР	MAX	UNIT
	HDBL101G HDBL102G HDBL103G		V _F	-	1.0	V
Forward voltage per diode ⁽¹⁾	HDBL104G	$I_F = 1A, T_J = 25^{\circ}C$		-	1.3	V
	HDBL105G HDBL106G HDBL107G			-	1.7	V
Reverse current @ rated V_R per diode ⁽²⁾		$T_J = 25^{\circ}C$	1	-	5	μA
		T _J = 125°C	I _R	-	500	μA
Reverse recovery time	HDBL101G HDBL102G HDBL103G HDBL104G	$I_F = 0.5A, I_R = 1.0A,$	t _{rr}	-	50	ns
	HDBL105G HDBL106G HDBL107G	I _{rr} = 0.25A		-	75	ns

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION					
ORDERING CODE ⁽¹⁾⁽²⁾	PACKAGE	PACKING			
HDBL10xG	DBL	50 / Tube			
HDBL10xGH	DBL	50 / Tube			

Notes:

1. "x" defines voltage from 50V(HDBL101G) to 1000V(HDBL107G)

2. "H" means AEC-Q101 qualified



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CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

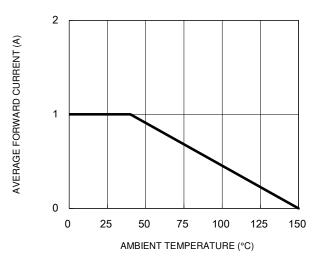
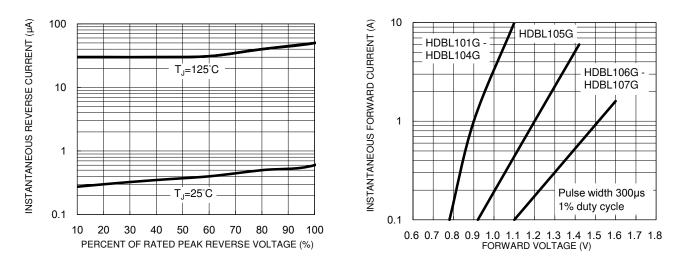


Fig.1 Forward Current Derating Curve

Fig.3 Typical Reverse Characteristics



100

10

1

0.1

f=1.0MHz Vsig=50mVp-p

CAPACITANCE (pF)

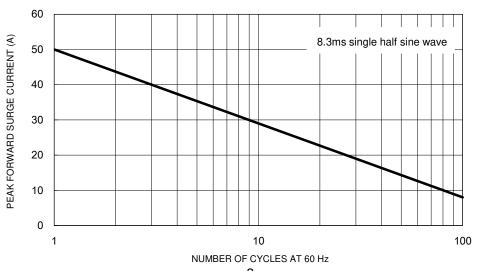


Fig.5 Maximum Non-Repetitive Forward Surge Current

Fig.2 Typical Junction Capacitance

HDBL106G - HDBL107G

1

HDBL101G - HDBL105G

10

REVERSE VOLTAGE (V)

Fig.4 Typical Forward Characteristics

100



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

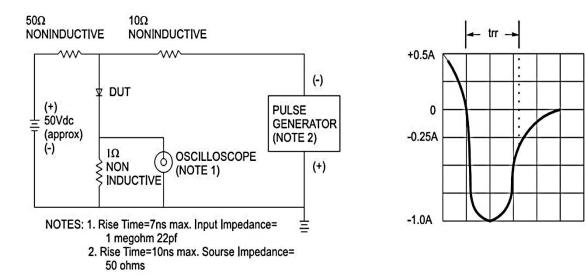


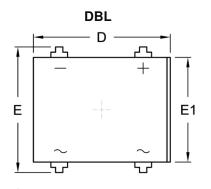
Fig.6 Reverse Recovery Time Characteristic and Test Circuit Diagram

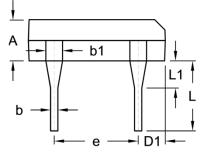


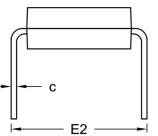
HDBL101G – HDBL107G

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PACKAGE OUTLINE DIMENSIONS







DIM.	Unit	(mm)	Unit (inch)		
	Min.	Max.	Min.	Max.	
A	2.40	2.60	0.094	0.102	
b	0.46	0.58	0.018	0.023	
b1	0.89	1.14	0.035	0.045	
с	0.22	0.33	0.009	0.013	
D	8.12	8.51	0.320	0.335	
D1	1.39	1.90	0.055	0.075	
е	5.00	5.20	0.197	0.205	
E	7.24	8.00	0.285	0.315	
E1	6.20	6.50	0.244	0.256	
E2	7.60	8.90	0.299	0.350	
L	3.81	4.69	0.150	0.185	
L1	1.27	2.03	0.050	0.080	

MARKING DIAGRAM



- P/N = Marking Code
- G = Green Compound
- YW = Date Code
- F = Factory Code



HDBL101G - HDBL107G

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